

Electronic Patent Application Fee Transmittal

Application Number:	10598644			
Filing Date:	31-Mar-2007			
Title of Invention:	Heat Insulation Panel Serving Also as Mold Form, and Outer Heat Insulation Structure			
First Named Inventor/Applicant Name:	Kazuo Kanetsuna			
Filer:	Joseph J. Corso/Debra Peterlin			
Attorney Docket Number:	KUM-41089			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 2 months with \$0 paid	1252	1	490	490

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				670